

Swan_soundbar DVT3 soldering review



ALT Co., Ltd.

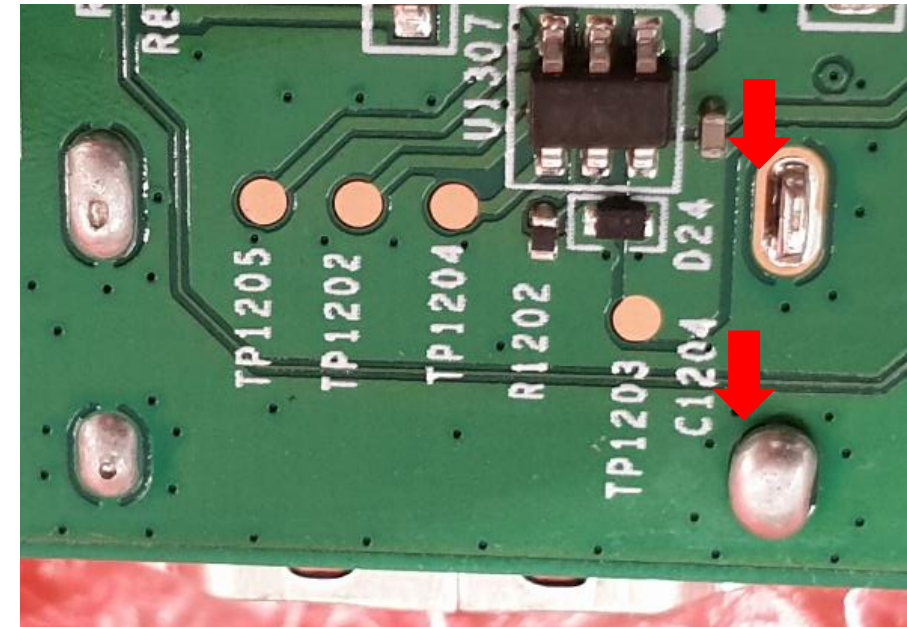
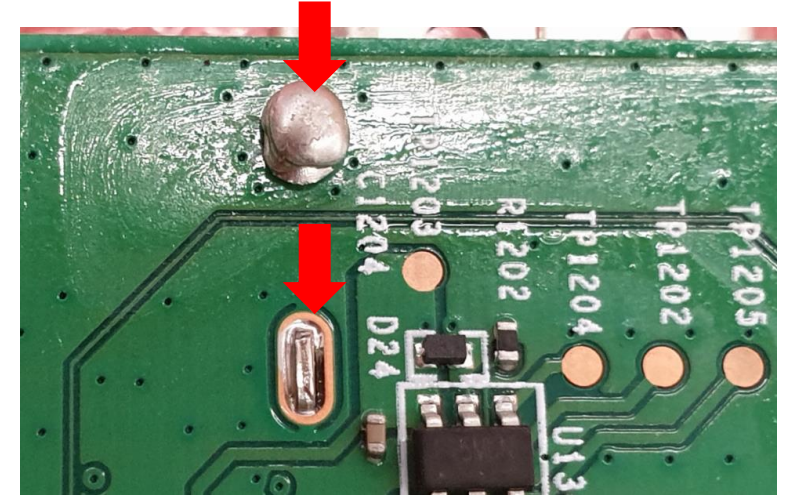
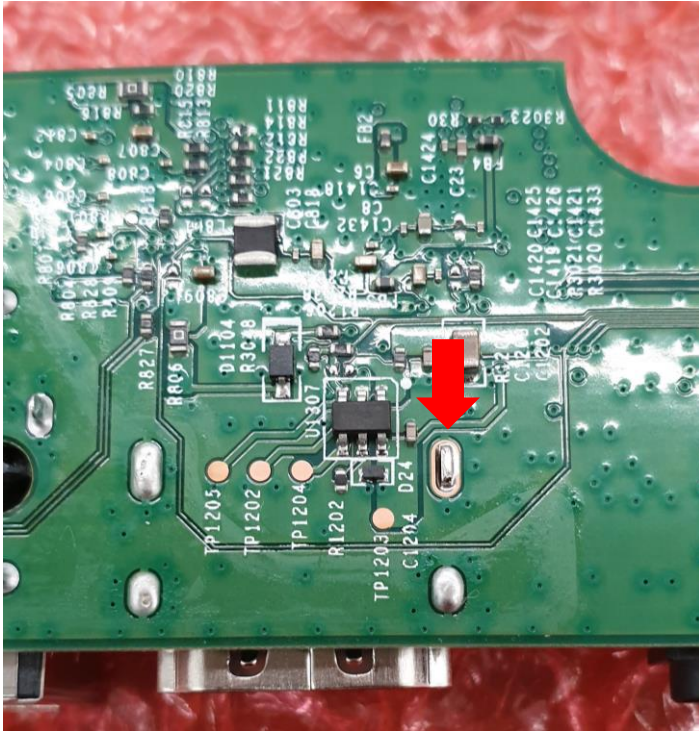
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Issued by SH, SON

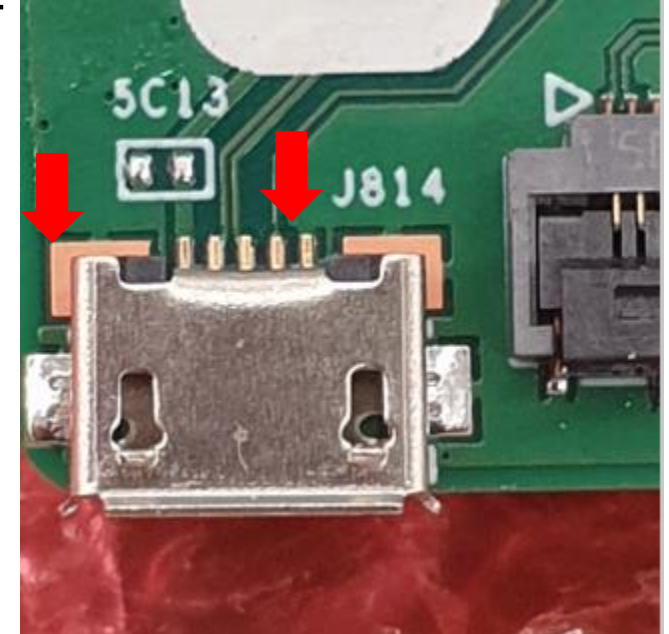
• SoC PCBA - Defect

- GND PIN not fully fill up - Defect.
 - 100%
- GND PIN soldering defect - lump of solder
 - 80%



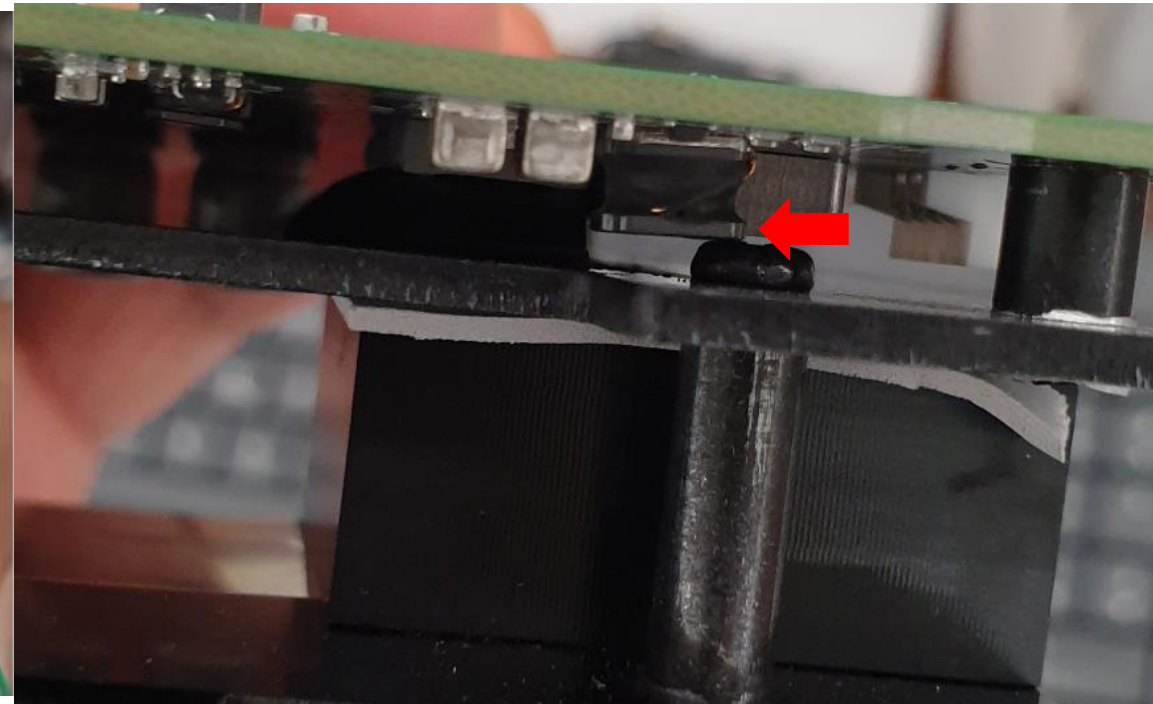
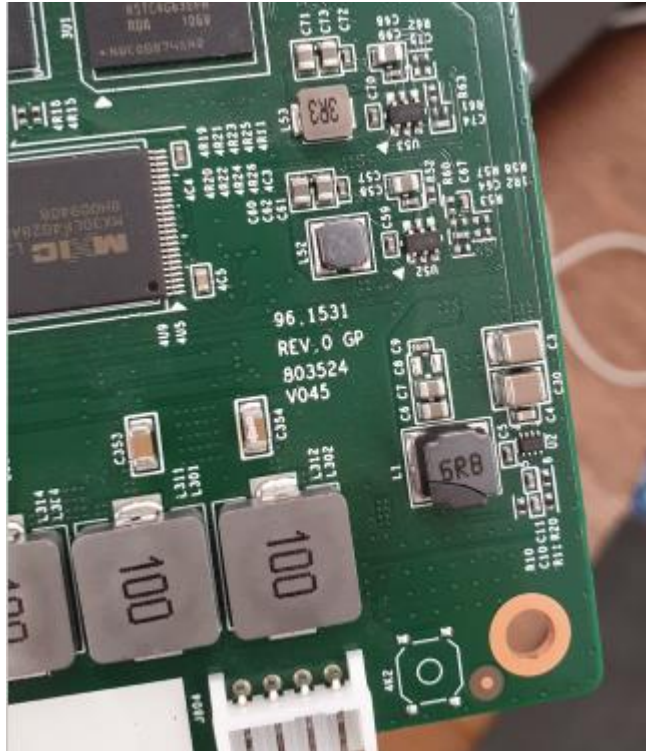
• AMP PCBA - Defect

- GND PIN not soldered.
 - 100%
- GND signal pin lack of solder
- Metal mask design must be updated
 - Report the before / after metal mask design for J814



- AMP PCBA - Defect

- Inductor L1 broken
 - 100%
 - Touched with heat spreader



- End of Documents